3.5 x2.8mm SMD CHIP LED LAMP

Part Number: APETD3528ZGC

Green



ATTENTION OBSERVE PRECAUTIONS FOR HANDLING ELECTROSTATIC DISCHARGE SENSITIVE DEVICES

Features

- Single color.
- Suitable for all SMT assembly and solder process.
- Available on tape and reel.
- Package: 500pcs / reel.
- Moisture sensitivity level : level 3.
- RoHS compliant.

Description

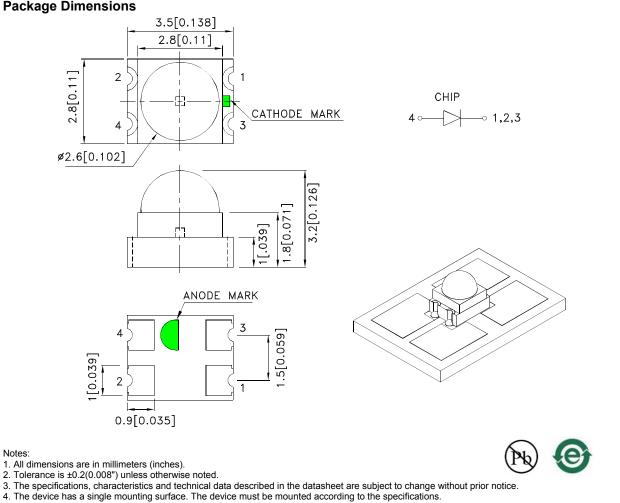
The Green source color devices are made with InGaN on Sapphire Light Emitting Diode.

Static electricity and surge damage the LEDS.

It is recommended to use a wrist band or anti-electrostatic glove when handling the LEDs.

All devices, equipment and machinery must be electrically grounded.

Package Dimensions



SPEC NO: DSAK3226 **APPROVED: WYNEC**

REV NO: V.2 **CHECKED:** Allen Liu DATE: APR/18/2011 DRAWN: J.Yu

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Selection Guide

Selection Guide					
Part No.	Dice	Lens Type	lv (mcd) [2] @ 20mA		Viewing Angle [1]
			Min.	Тур.	201/2
APETD3528ZGC	Green (InGaN)	Water Clear	1000	1800	60°

Notes:

θ1/2 is the angle from optical centerline where the luminous intensity is 1/2 of the optical peak value.
Luminous intensity/ luminous Flux: +/-15%.

Electrical / Optical Characteristics at TA=25°C

Symbol	Parameter	Device	Тур.	Max.	Units	Test Conditions	
λpeak	Peak Wavelength	Green	515		nm	I⊧=20mA	
λD [1]	Dominant Wavelength	Green	525		nm	I⊧=20mA	
Δλ1/2	Spectral Line Half-width	Green	30		nm	I⊧=20mA	
С	Capacitance	Green	45		pF	VF=0V;f=1MHz	
VF [2]	Forward Voltage	Green	3.3	4.1	V	I⊧=20mA	
lr	Reverse Current	Green		50	uA	Vr=5V	

Notes:

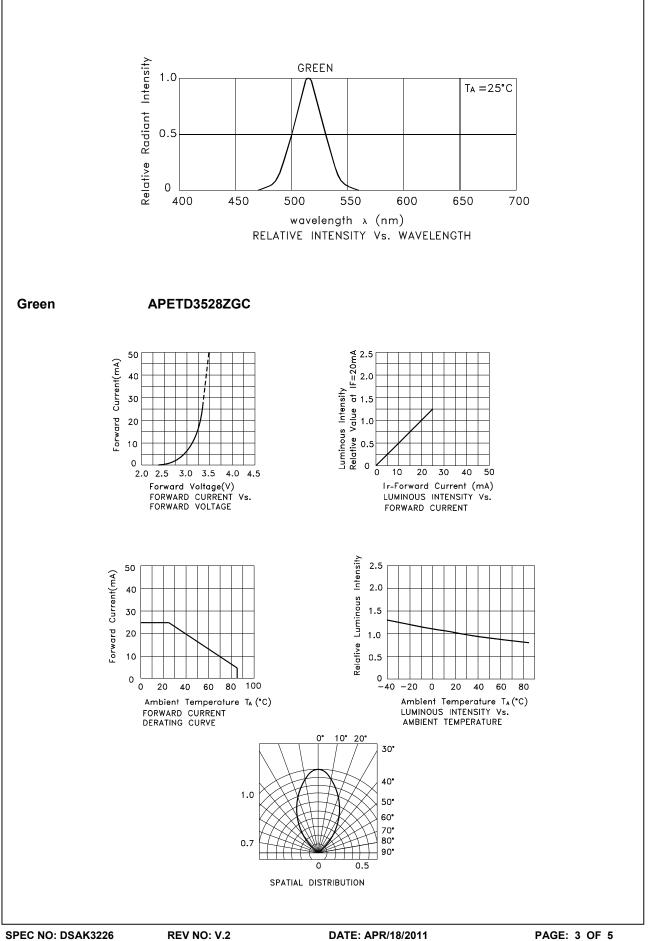
1.Wavelength: +/-1nm. 2. Forward Voltage: +/-0.1V.

Absolute Maximum Ratings at TA=25°C

Parameter	Green	Units		
Power dissipation	102.5	mW		
DC Forward Current	25	mA		
Peak Forward Current [1]	150	mA		
Reverse Voltage	5	V		
Operating Temperature	-40°C To +85°C			
Storage Temperature	-40°C To +85°C			

Note:

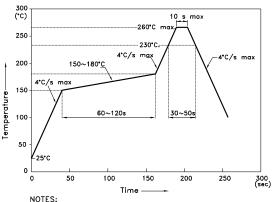
1. 1/10 Duty Cycle, 0.1ms Pulse Width.



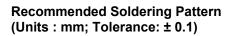
APETD3528ZGC

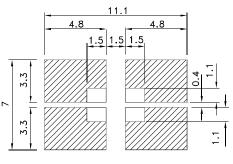
Reflow soldering is recommended and the soldering profile is shown below. Other soldering methods are not recommended as they might cause damage to the product.

Reflow Soldering Profile For Lead-free SMT Process.



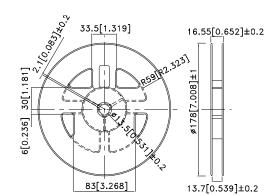
NOTES: 1.We recommend the reflow temperature 245°C(+/-5°C).The maximum soldering temperature should be limited to 260°C. 2.Don't cause stress to the epoxy resin while it is exposed to high temperature. 3.Number of reflow process shall be 2 times or less.



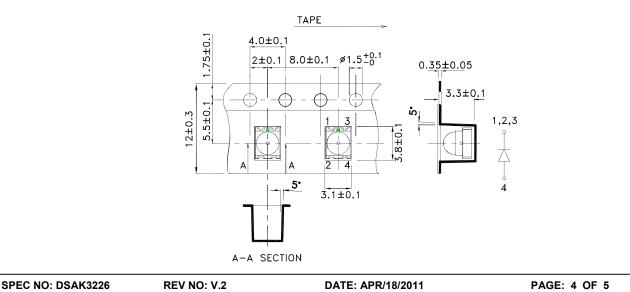


🛛 Solder resist

Reel Dimension



Tape Dimensions (Units : mm)



APPROVED: WYNEC

CHECKED: Allen Liu

DRAWN: J.Yu

ERP: 1203010680

